

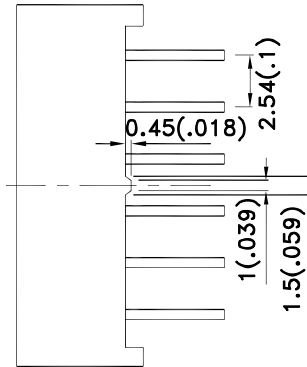
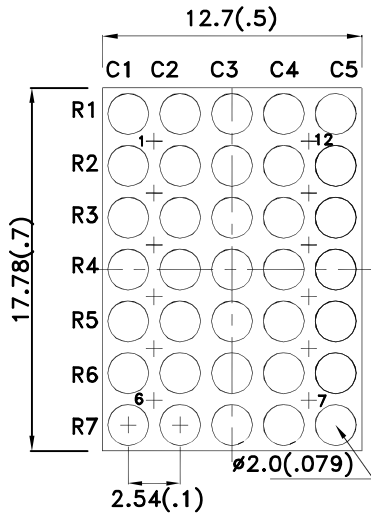
### Features

- 0.7 inch matrix height.
- Dot size 2mm.
- Low current operation.
- Stackable vertically and horizontally.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard: gray face, white dot.
- RoHS compliant.

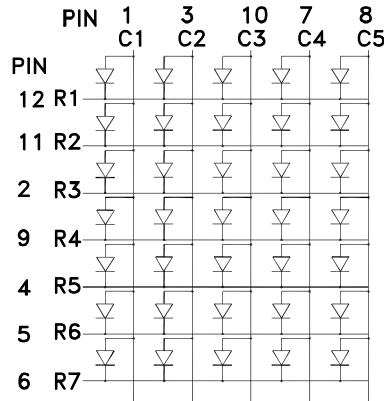
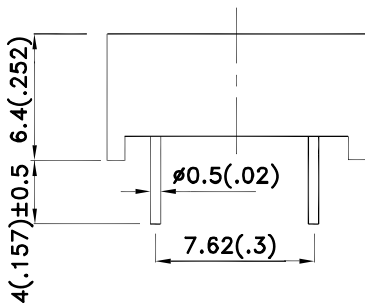
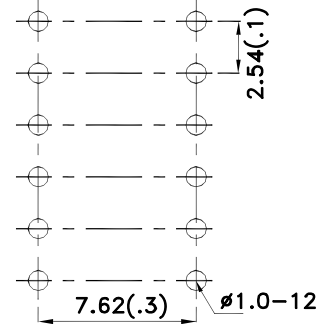
### Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

### Package Dimensions & Internal Circuit Diagram



### RECOMMENDED PCB LAYOUT



Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

## Selection Guide

| Part No.   | Dice                            | Lens Type      | Iv (ucd) [1]<br>@ 10mA |      | Description  |
|------------|---------------------------------|----------------|------------------------|------|--------------|
|            |                                 |                | Min.                   | Typ. |              |
| TA07-11EWA | High Efficiency Red (GaAsP/GaP) | White Diffused | 3600                   | 8200 | Column Anode |

Note:

1. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

| Symbol                | Parameter                | Device              | Typ. | Max. | Units | Test Conditions           |
|-----------------------|--------------------------|---------------------|------|------|-------|---------------------------|
| $\lambda_{peak}$      | Peak Wavelength          | High Efficiency Red | 627  |      | nm    | I <sub>F</sub> =20mA      |
| $\lambda_D$ [1]       | Dominant Wavelength      | High Efficiency Red | 625  |      | nm    | I <sub>F</sub> =20mA      |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | High Efficiency Red | 45   |      | nm    | I <sub>F</sub> =20mA      |
| C                     | Capacitance              | High Efficiency Red | 15   |      | pF    | V <sub>F</sub> =0V;f=1MHz |
| V <sub>F</sub> [2]    | Forward Voltage          | High Efficiency Red | 2.0  | 2.5  | V     | I <sub>F</sub> =20mA      |
| I <sub>R</sub>        | Reverse Current          | High Efficiency Red |      | 10   | uA    | V <sub>R</sub> =5V        |

Notes:

1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

| Parameter                       | High Efficiency Red   | Units |
|---------------------------------|-----------------------|-------|
| Power dissipation               | 75                    | mW    |
| DC Forward Current              | 30                    | mA    |
| Peak Forward Current [1]        | 160                   | mA    |
| Reverse Voltage                 | 5                     | V     |
| Operating / Storage Temperature | -40°C To +85°C        |       |
| Lead Solder Temperature[2]      | 260°C For 3-5 Seconds |       |

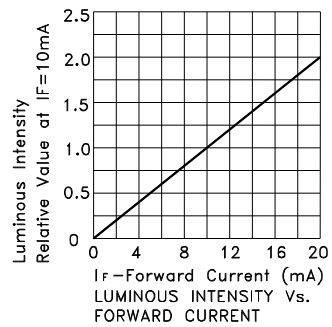
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

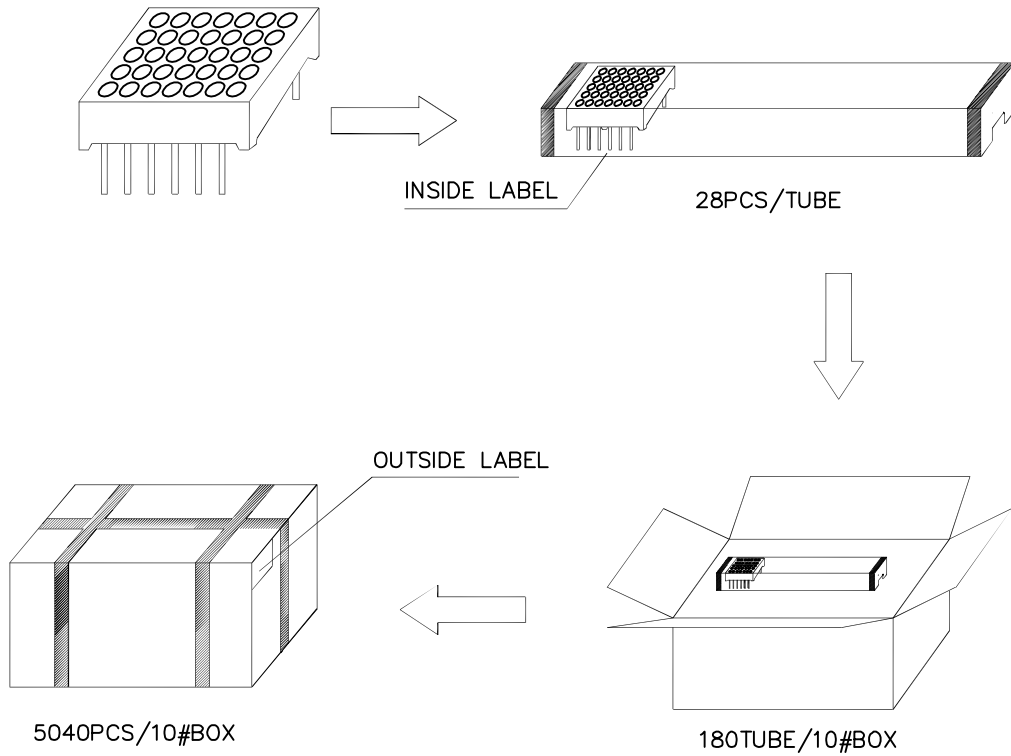


## High Efficiency Red TA07-11EWA

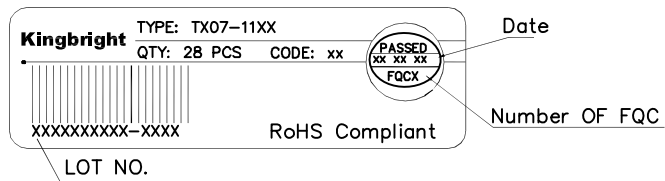


## PACKING & LABEL SPECIFICATIONS

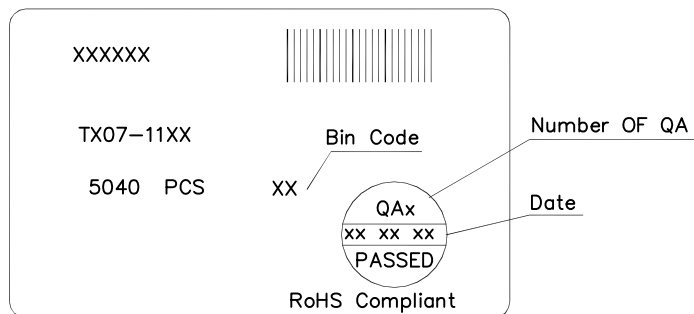
## TA07-11EWA



### Inside Label On IC-TUBE



### Outside Label On Box



## THROUGH HOLE DISPLAY MOUNTING METHOD

### Lead Forming

Do not bend the component leads by hand without proper tools.  
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



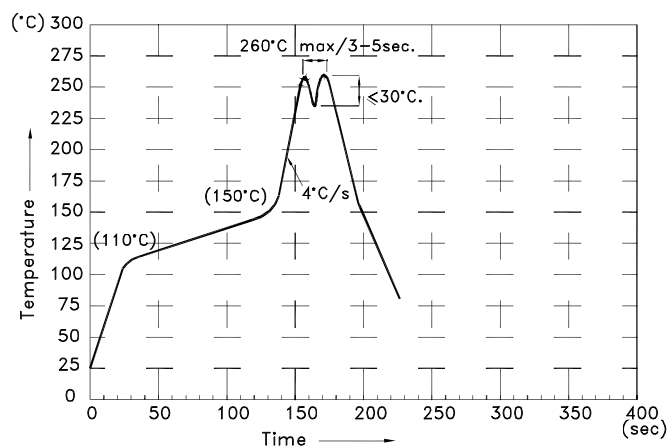
### Installation

- 1.The installation process should not apply stress to the lead terminals.
- 2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



## DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
- 5.No more than once.

## Soldering General Notes:

- a. Through-hole displays are incompatible with reflow soldering.
- b. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

## CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

## CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.

